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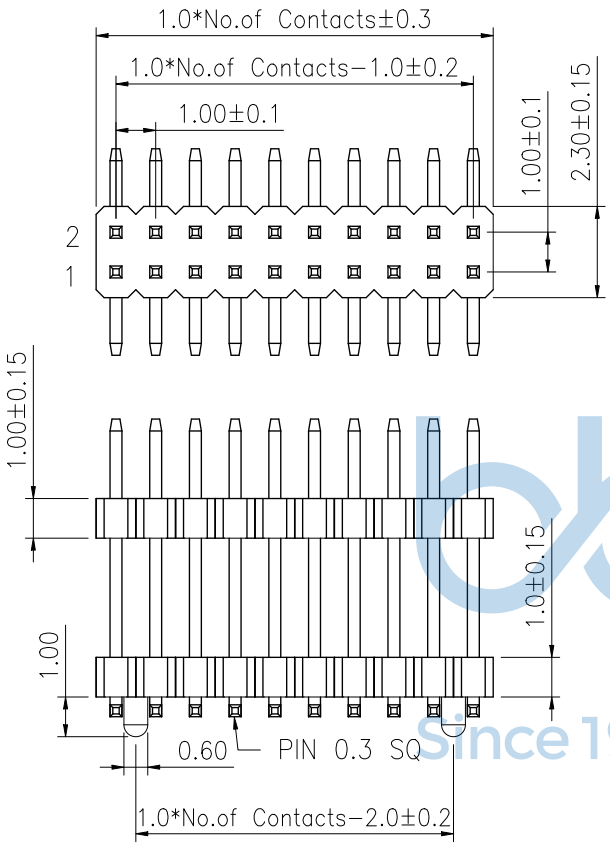
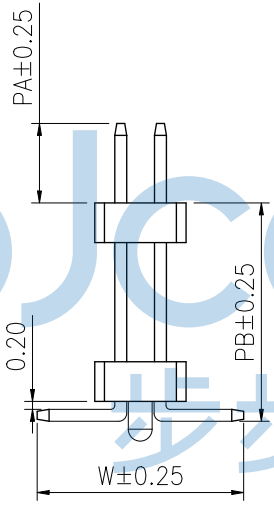
REV.	ECN NO	CONTENT	DATE	ENGINEER
A0				





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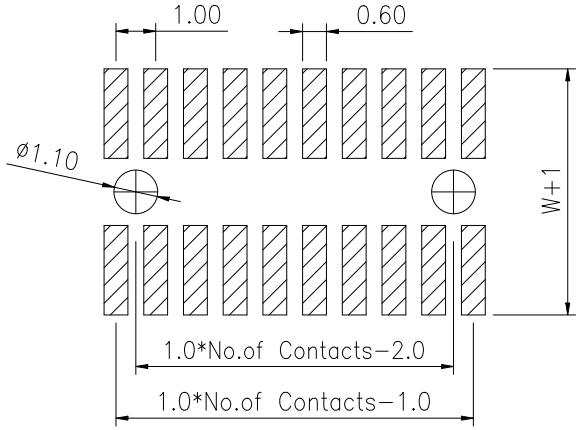

PCB LAYOUT

SPECIFICATIONS

Currrnt Rating:1 AMP
Insulator Resistance:1000MΩ Min.
Contact Resistance:20mΩ Max.
Withstanding Voltage:AC 500V
Operating Temperature:-40℃ to +105℃
Max Processing Temp:230° -260° for 30-60 seconds
Insulator:Glass filled PA6T (UL94V-0),Black
Contacts:Brass

Dimension antitheses list				
ITEM	PA	PB	W	L
Alternate	1.90	14.15	4.80	17.6

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BBJconn Technology Co., Ltd Green Product Compliant RoHS

深圳市步步精科技有限公司 BBJconn Technology Co., Ltd APPROVED 工程部

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深圳市步步精科技有限公司

.X: ±0.38 X°: ±3°
.XX: ±0.25 .X°: ±2°
.XXX: ±0.13 .XX°: ±1°

NAME: 排针 1.0PH H1.0 2x12P SMT 带柱 双塑 W4.8 PA1.9 PB14.15 L17.6 PA6T 加盖编带

APPD.	JM_Zheng	PJ. NO.: PH.02.32-11-9001	
CHKD.	LYX	SIZE: A4	DRW NO.:
DR.	TSP	FINISH: SEE NOTES	MAT'L.: SEE NOTES
PDWG,NO: 0774-1		SCALE: N/A REV.: A0	UNIT: mm PAGE: 1/1